ABBOCIATION CONNECTING ELECTRONICS INDUSTRIES® Material Comp © Copyright 2005. Il international and Par	PC, Bannockt	ourn, Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a decla the declaratio	ration of th n encompa	ne substances asses all lowe	within the er level mate	manufacture erials for wh	er listed ite ich the ma	m. Note: if nufacturer	the item is an as has engineering	sembly with lowe responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribut				e *	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
Supplier Information															
Company name*	Company un	Company unique ID			Unique ID Authority					Response Date*					
onsemi											2023-06-08				
Contact Name	Title - Conta	Title - Contact			Phone - Contact*					Email - Contact*					
Product-Env-Stewards	Product Envi	Product Enviro Compliance			NA					Product-Env-Stewards@onsemi.com					
Authorized Representative*	Title - Representative			Phone - Representative*				Email - Representative*							
Product-Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
Requester Item Number	Mfr Item	n Number	Mfr Item Name			Effective Date Version Manufacturing Site		ing Site	W	eight*	UOM	Unit Type			
	LC717A	10AR-NH	TOUCH SENSOR 16CH			2023-06-08			РНМ		20	).0	mg	Each	
Manufacturing Proccess Information	ion						·				ł			l	
Terminal Plating / Grid Array Ma	terial 7	Ferminal Base	Alloy	J-STD-020 MSL Rating		Peak Process Body Tem		ly Temperatu	rature Max Time at Peak T		Femperatu	emperature Number of Reflow Cycles		les	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 3		3		260		C	30		second	s 3			
Comments															
TTENTION: MSL 3 Rated item require	Bake and D	Dry Pack (after	electrical test)												
or more information regarding material	composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	oHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl hthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.44	mg	Supplier	Silicon (Si)	7440-21-3		1.4308	mg
			Supplier	Polyimide	Proprietary Data		0.0092	mg
Die Attach 0.06	0.06	mg	Supplier	Epoxy resins	129915-35-1		0.0435	mg
			Supplier	Acrylic resins	Proprietary Data		0.0165	mg
Mold Compound-Black 13	13.87	mg		Epoxy Phenol Resin	proprietary data		1.5257	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0277	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		11.7618	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.5548	mg
Substrate and Solder Mask	4.4	mg	В	Nickel (Ni)	7440-02-0		0.3164	mg
			Supplier	Gold (Au)	7440-57-5		0.0682	mg
			Supplier	Bismaleimide Triazine resin	Proprietary Data		2.6893	mg
			Supplier	Copper (Cu)	7440-50-8		1.3262	mg
Wire Bond - Au	0.23	mg	Supplier	Gold (Au)	7440-57-5		0.23	mg